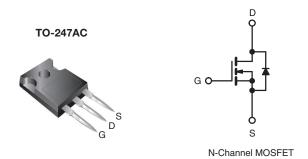


### Power MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	600				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 1.2				
Q <sub>g</sub> (Max.) (nC)	60				
Q <sub>gs</sub> (nC)	8.3				
Q <sub>gd</sub> (nC)	30				
Configuration	Single				



### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC





### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

TO-247AC The package preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFPC40PbF
Lead (FD)-lifee	SiHFPC40-E3
SnPb	IRFPC40
SIFD	SiHFPC40

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	600	V
Gate-Source Voltage			$V_{GS}$	± 20	V
T <sub>C</sub> = 25 °C			6.8		
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_C = 25 \degree C$ $T_C = 100 \degree C$	I <sub>D</sub>	4.3	Α
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	27	
Linear Derating Factor				1.2	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	410	mJ
Maximum Power Dissipation $T_C = 25 ^{\circ}C$			$P_{D}$	150	W
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	3.0	V/ns
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C
Soldering Recommendations (Peak Temperature) for 10 s				300 <sup>d</sup>	7
Mauratina Taurus			10	lbf ⋅ in	
Mounting Torque	6-32 or M3 screw			1.1	N · m

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 16 mH,  $R_g = 25$   $\Omega$ ,  $I_{AS} = 6.8$  A (see fig. 12). c.  $I_{SD} \le 6.8$  A,  $I_{AS} = 6.8$  A (see fig. 12).
- d. 1.6 mm from case

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS						
PARAMETER SYMBOL TYP. MAX. UNIT						
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40			
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24	-	°C/W		
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	0.83			

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 1 mA	-	0.70	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	<sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>G</sub>	<sub>S</sub> = ± 20 V	-	-	± 100	nA
Zone Ooto Voltage Dusin Ormant		V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	-	100	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V, \	/ <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 4.1 A <sup>b</sup>	-	-	1.2	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 10	00 V, I <sub>D</sub> = 4.1 A <sup>b</sup>	4.9	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	V	<sub>GS</sub> = 0 V,	-	1300	-	
Output Capacitance	C <sub>oss</sub>	V <sub>I</sub>	os = 25 V,	-	160	-	рF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0	MHz, see fig. 5	-	30	-	
Total Gate Charge	Qg		V <sub>GS</sub> = 10 V		-	60	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V			-	8.3	nC
Gate-Drain Charge	$Q_{gd}$	see lig. 0 and 10		-	-	30	
Turn-On Delay Time	t <sub>d(on)</sub>		'		13	-	ns
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = 300 V, I <sub>D</sub> = 6.2 A ,		-	18	-	
Turn-Off Delay Time	t <sub>d(off)</sub>		$V_{DD} = 300 \text{ V}, I_D = 6.2 \text{ A},$ $R_g = 9.1 \Omega, R_D = 47 \Omega, \text{ see fig. } 10^{\text{b}}$		55	-	
Fall Time	t <sub>f</sub>	1		-	20	-	
Internal Drain Inductance	L <sub>D</sub>	` ,	Between lead, 6 mm (0.25") from		5.0	-	ml I
Internal Source Inductance	L <sub>S</sub>	package and center of die contact		-	13	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	showing the	MOSFET symbol showing the		-	6.8	Α
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	27	A
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>5</sub>	$_{S} = 6.8 \text{ A}, V_{GS} = 0 \text{ V}^{b}$	-	-	1.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 25 °C !	6 2 A dl/dt = 100 A/usb	ı	450	940	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$	$T_J = 25  ^{\circ}\text{C}, I_F = 6.2  \text{A}, dI/dt = 100  \text{A}/\mu \text{s}^{\text{b}}$		_	3.8	7.9	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )				L <sub>D</sub> )	

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

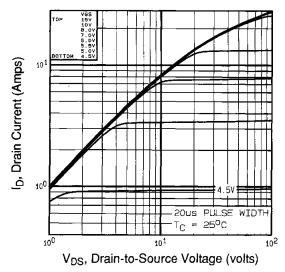


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

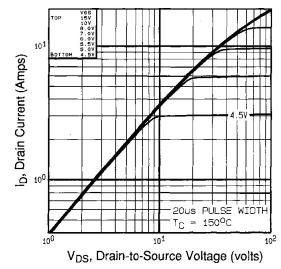


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

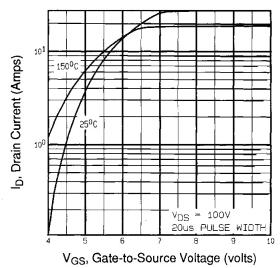


Fig. 3 - Typical Transfer Characteristics

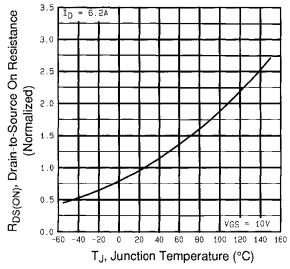


Fig. 4 - Normalized On-Resistance vs. Temperature



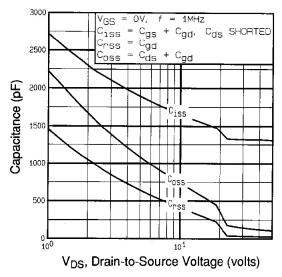


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

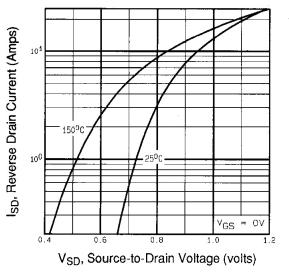


Fig. 7 - Typical Source-Drain Diode Forward Voltage

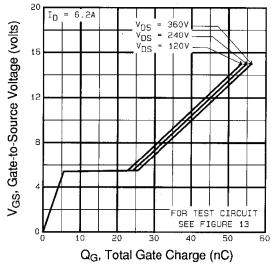


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

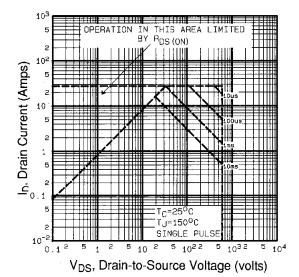


Fig. 8 - Maximum Safe Operating Area





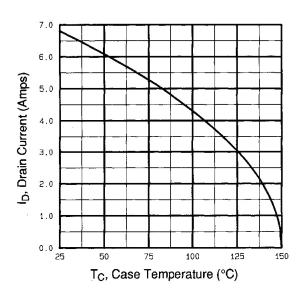


Fig. 9 - Maximum Drain Current vs. Case Temperature

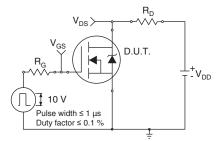


Fig. 10a - Switching Time Test Circuit

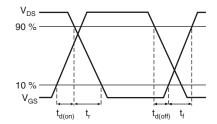


Fig. 10b - Switching Time Waveforms

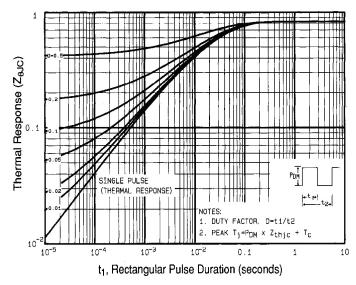
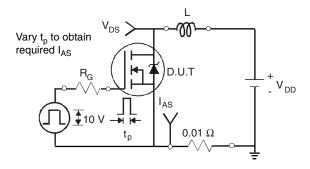


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





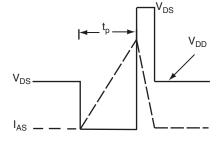


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

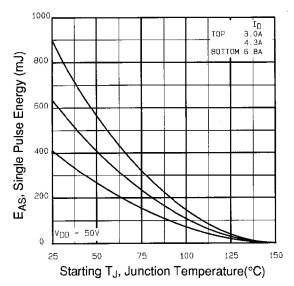


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

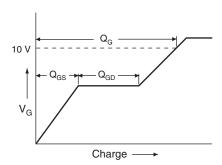


Fig. 13a - Basic Gate Charge Waveform

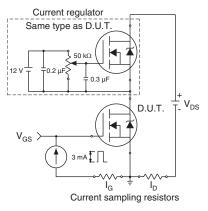
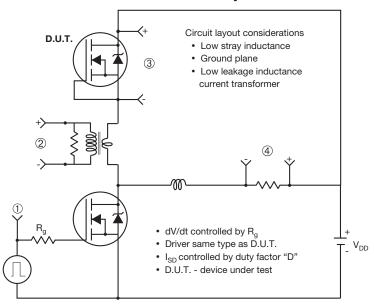


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



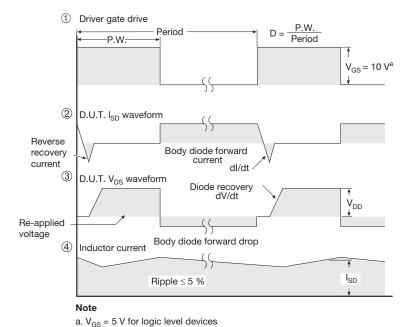


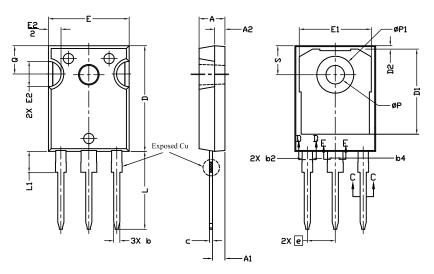
Fig.14 - For N-Channel

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# **TO-247AC (High Voltage)**

### **VERSION 1: FACILITY CODE = 9**







Section C--C,D--D,E--E

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
Α	4.83	5.21	
A1	2.29	2.55	
A2	1.50	2.49	
b	1.12	1.33	
b1	1.12	1.28	
b2	1.91	2.39	6
b3	1.91	2.34	
b4	2.87	3.22	6, 8
b5	2.87	3.18	
С	0.55	0.69	6
c1	0.55	0.65	
D	20.40	20.70	4

	MILLIM		
DIM.	MIN.	MAX.	NOTES
D1	16.25	16.85	5
D2	0.56	0.76	
E	15.50	15.87	4
E1	13.46	14.16	5
E2	4.52	5.49	3
е	5.44	BSC	
L	14.90	15.40	
L1	3.96	4.16	6
ØΡ	3.56	3.65	7
Ø P1	7.19		
Q	5.31	5.69	
S	5.54	5.74	

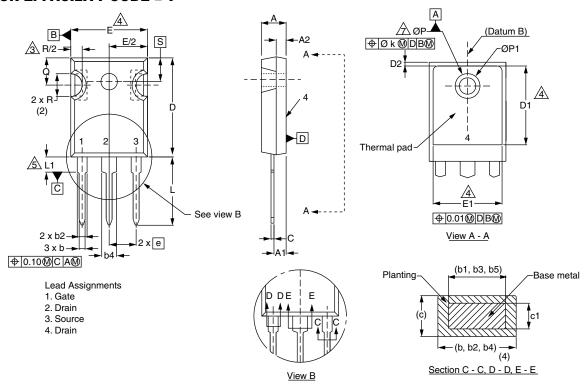
#### Notes

- (1) Package reference: JEDEC® TO247, variation AC
- (2) All dimensions are in mm
- (3) Slot required, notch may be rounded
- (4) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- (5) Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- $^{(7)}$  Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition

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### **VERSION 2: FACILITY CODE = Y**



	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
Α	4.58	5.31	
A1	2.21	2.59	
A2	1.17	2.49	
b	0.99	1.40	
b1	0.99	1.35	
b2	1.53	2.39	
b3	1.65	2.37	
b4	2.42	3.43	
b5	2.59	3.38	
С	0.38	0.86	
c1	0.38	0.76	
D	19.71	20.82	
D1	13.08	-	

	MILLIN		
DIM.	MIN.	MAX.	NOTES
D2	0.51	1.30	
Е	15.29	15.87	
E1	13.72	-	
е	5.46	BSC	
Øk	0.2	254	
L	14.20	16.25	
L1	3.71	4.29	
ØР	3.51	3.66	
Ø P1	-	7.39	
Q	5.31	5.69	
R	4.52	5.49	
S	5.51 BSC		
	•		

### Notes

DWG: 5971

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1

ECN: E19-0614-Rev. E, 08-Jan-2020

- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC outline TO-247 with exception of dimension c



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Vishay

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